

Predicting and Correcting Board-Level Signal Integrity Problems in High Data Rate Digital Systems

Ansoft Design Forum
June 2002

Agenda

- ◆ Description of the Signal Integrity problems.
- ◆ Simulating the effects.
- ◆ Strategies for mitigating the effects.
- ◆ Predicting the system-level performance.
- ◆ Summary.

Power and Groundplane Resonances

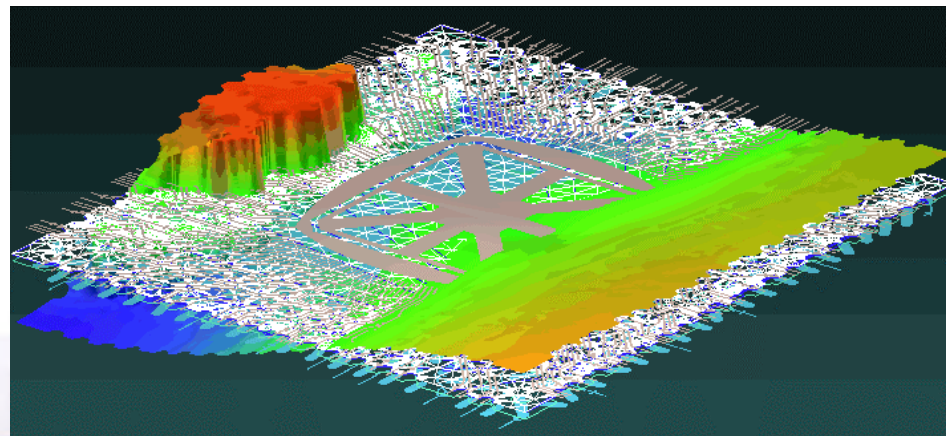
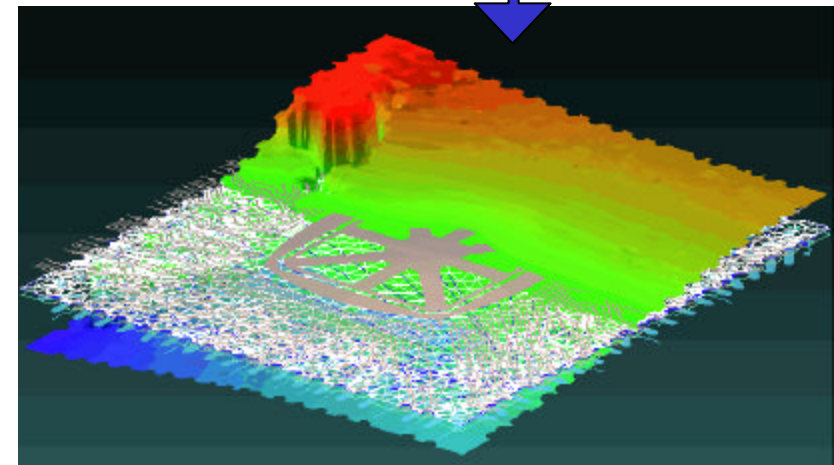
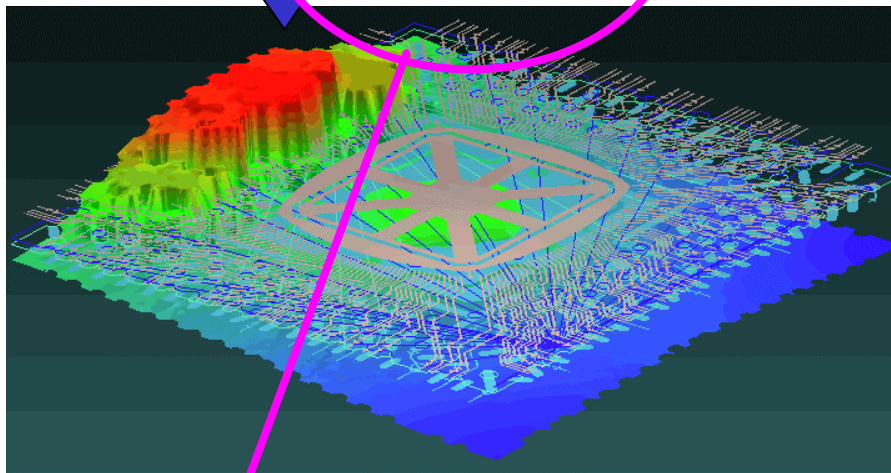
- ◆ What are they?
 - ◆ Electromagnetic standing waves set up in the dielectrics between the conducting planes.
- ◆ Why should we worry?
 - ◆ They cause non-local coupling.
 - ◆ Strongly frequency dependent.
- ◆ How can we handle them?
 - ◆ Using Full-Wave electromagnetic analysis.....
 - ◆ SIwave and HFSS.

Modelling BGA Board Resonances and Quantifying Decoupling Strategies

- ◆ Full model of a BGA board, translated by AnsoftLinks from Cadence APD.
- ◆ SIwave analyses resonant frequencies and modal shapes.
- ◆ Decoupling capacitors placed interactively and system re-simulated.

Power/Ground Resonances

Re. Freq (GHz)	Im. Freq (GHz)	k	Wavelength (m)
2.319178636	0.019977656	48.60639000	0.129266652
2.762208531	0.022483041	57.89161000	0.108533608
3.558985002	0.028734830	74.59081000	0.084235381

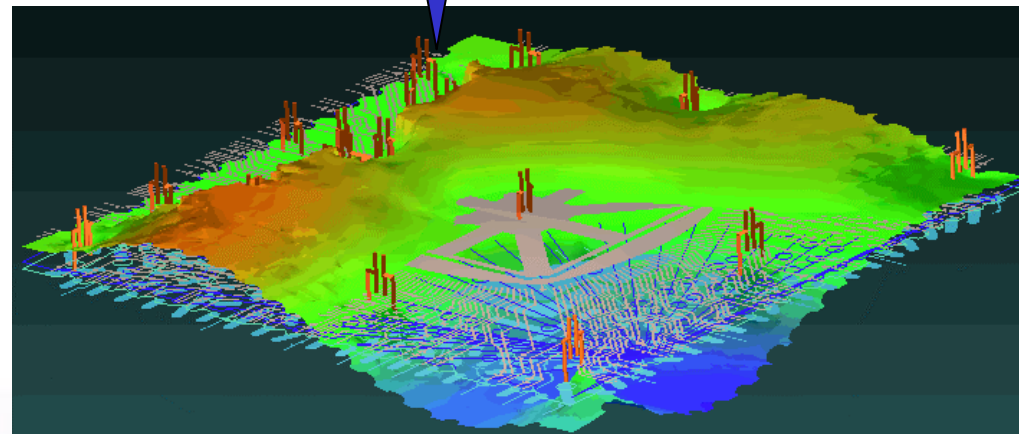
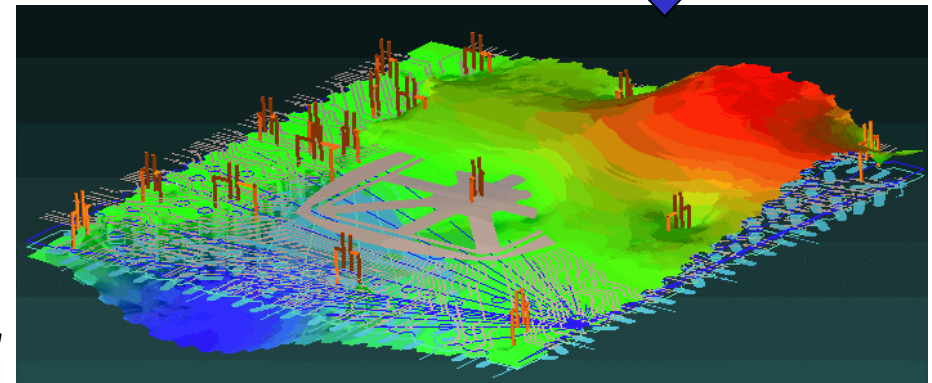
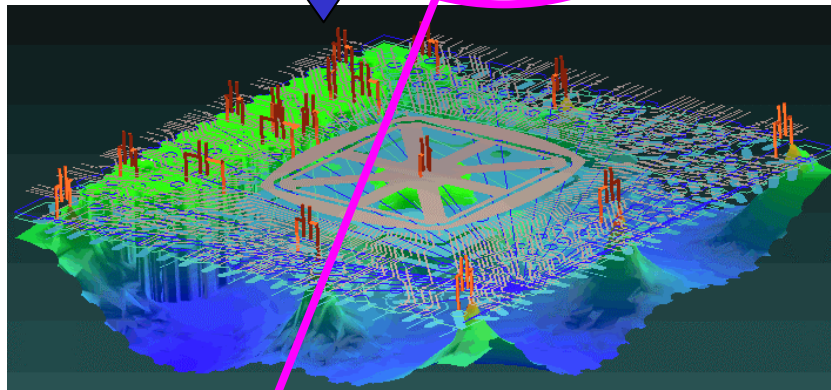


Note
frequency
range



Decoupling Capacitors Added

Re. Freq (GHz)	Im. Freq (GHz)	k	Wavelength (m)
4.247993008	0.034713793	89.03135000	0.070572729
4.692164209	0.037825497	98.34049000	0.063892150
5.247348866	0.042215898	109.97630000	0.057132176



Note higher frequency range (factor of 2)



Interactive Placement of Capacitors and Damping Resistors

- ◆ SIwave assumes E field in resonant modes is Z-directed: a good approximation up to several hundred GHz.
- ◆ Allows us to use a Scalar formulation: much faster than a full 3D analysis.
- ◆ So can place components interactively.
- ◆ Allows designers to develop cost-effective decoupling arrangements.

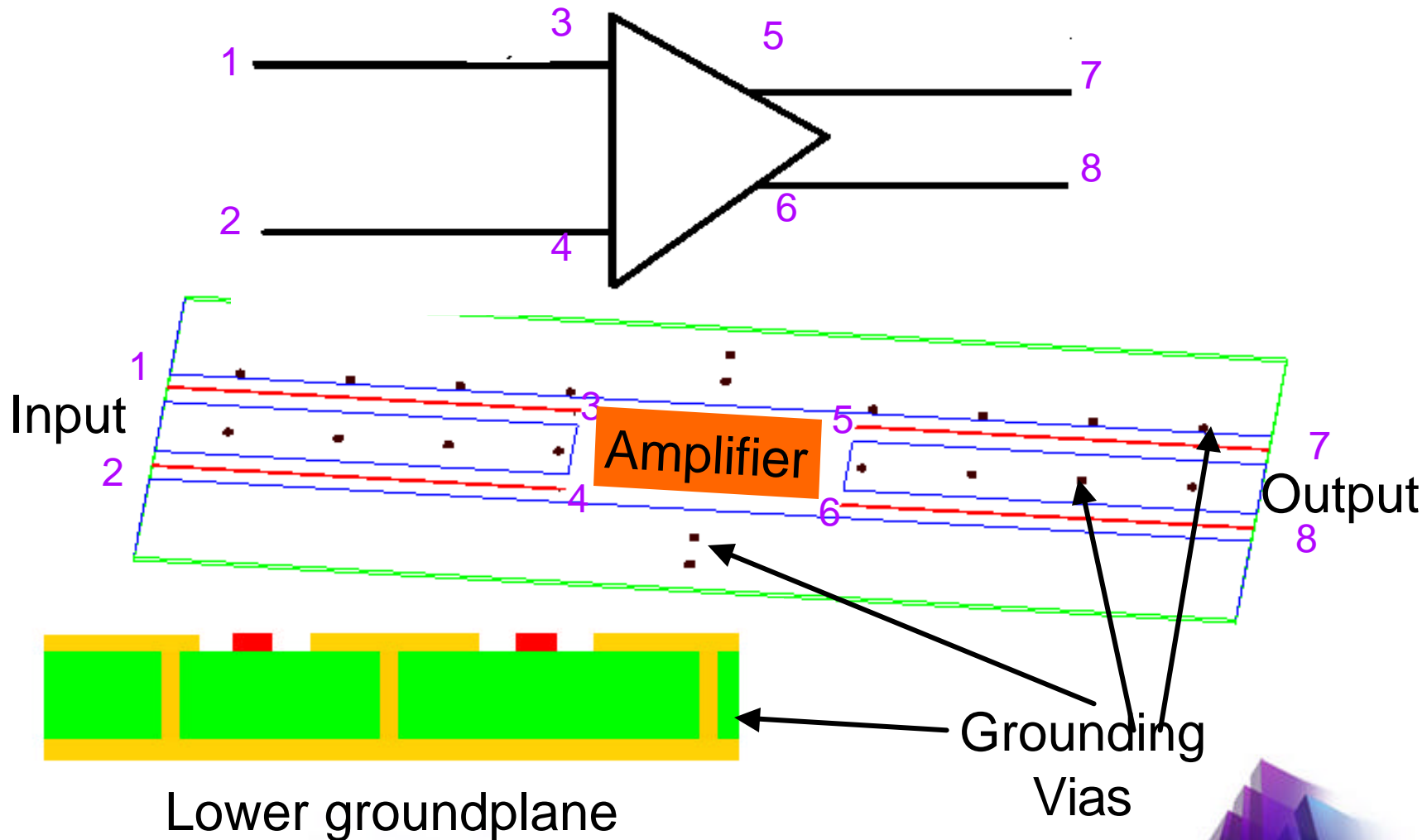
Optical Transceiver Amplifier

- ◆ Simplified geometry.
- ◆ Actual board layout is confidential.
- ◆ Simple example is faithful to the impedances and frequency ranges: it shows all the effects without putting me in court!

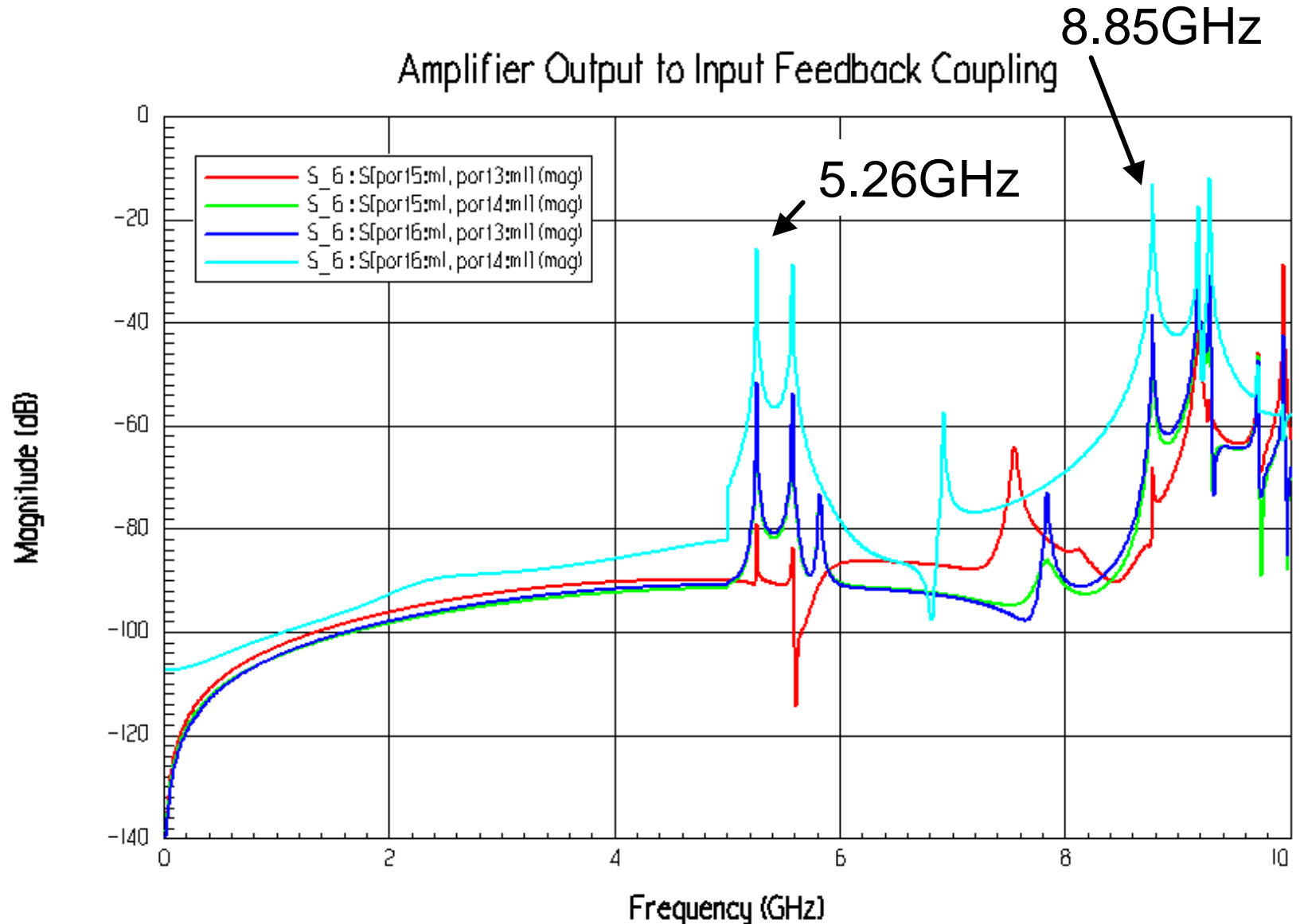


Simplified PCB Model

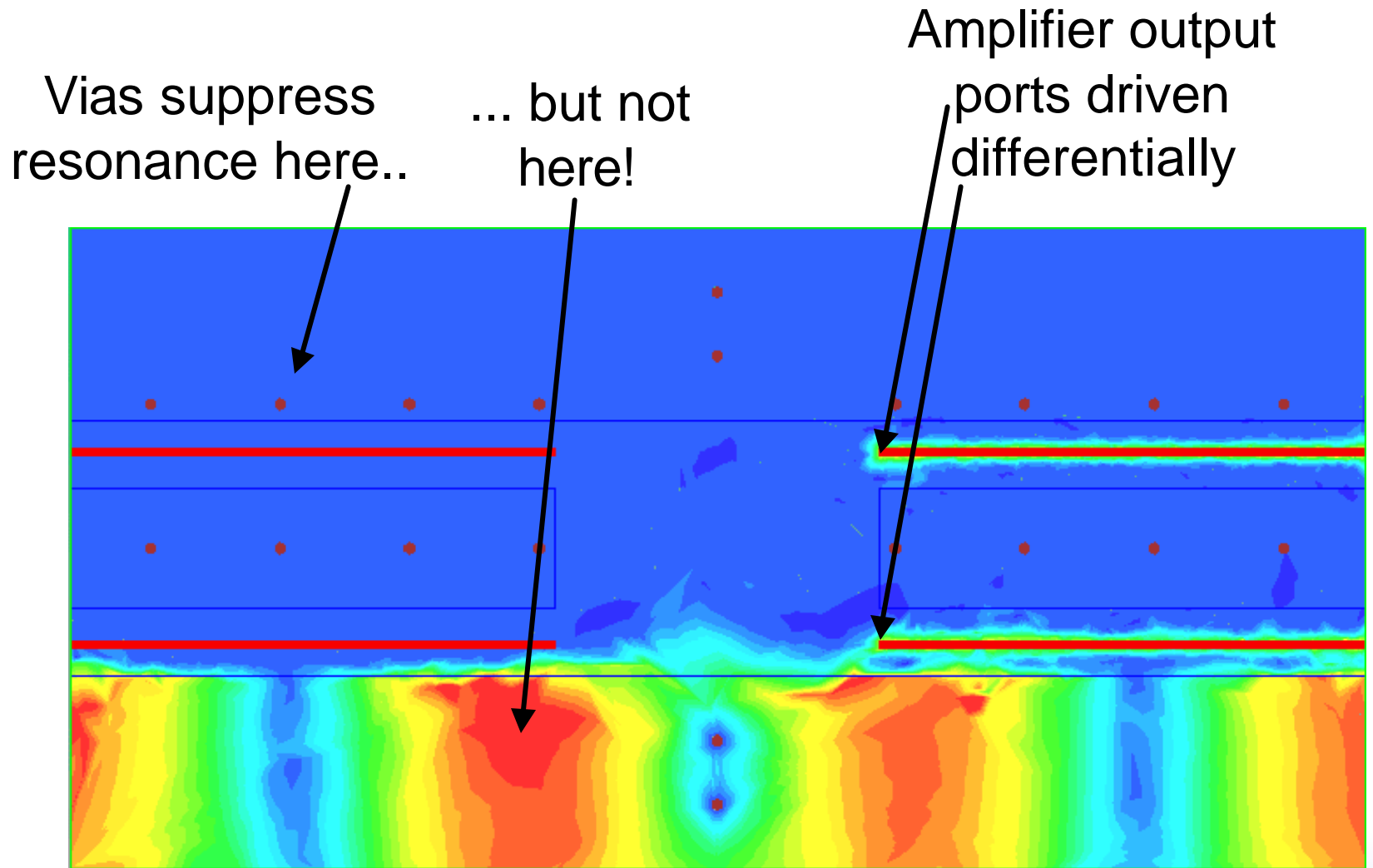
Illustrating Resonance Effects



Coupling from Amplifier Output to Input

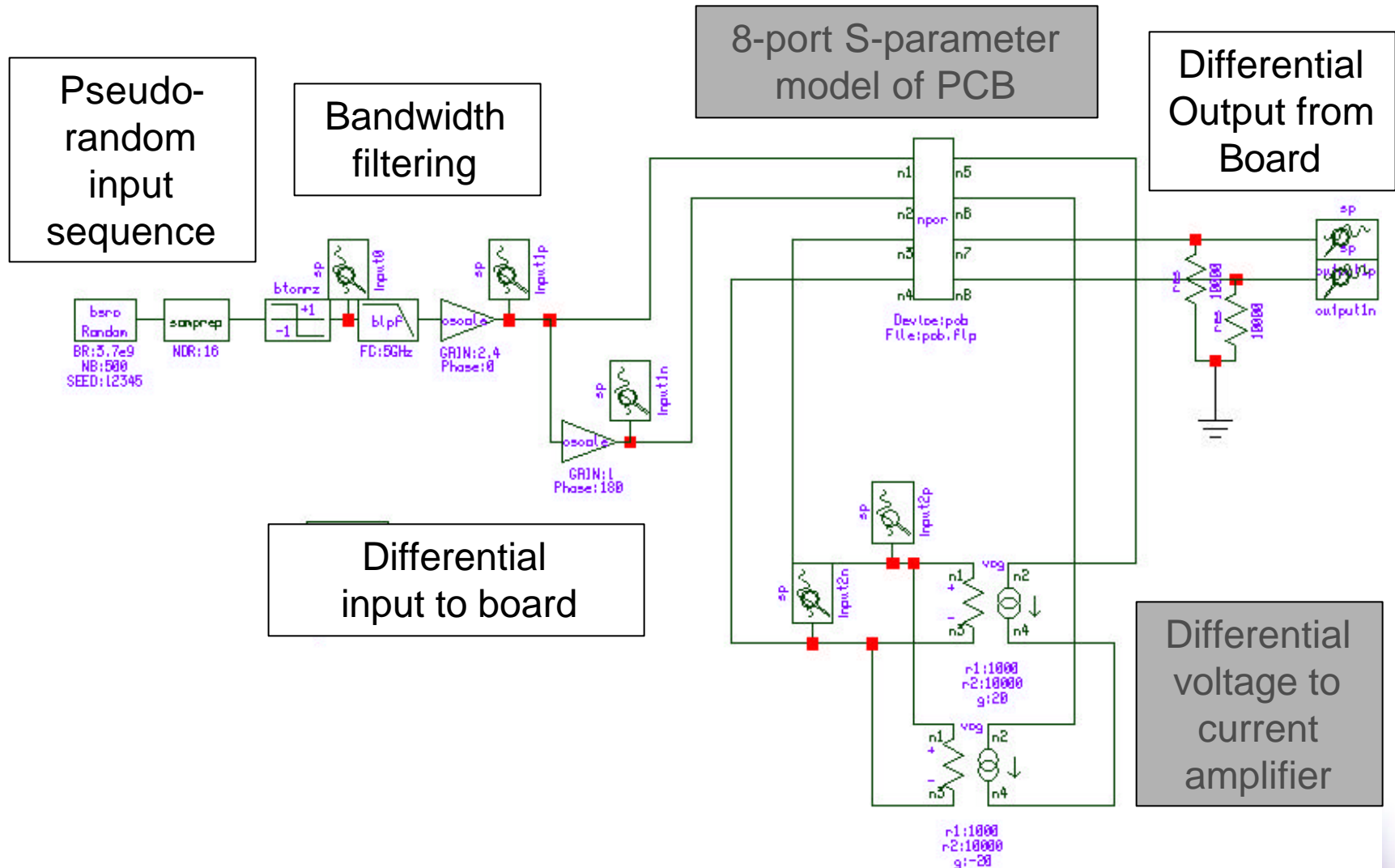


Electric Field in Dielectric at Resonance



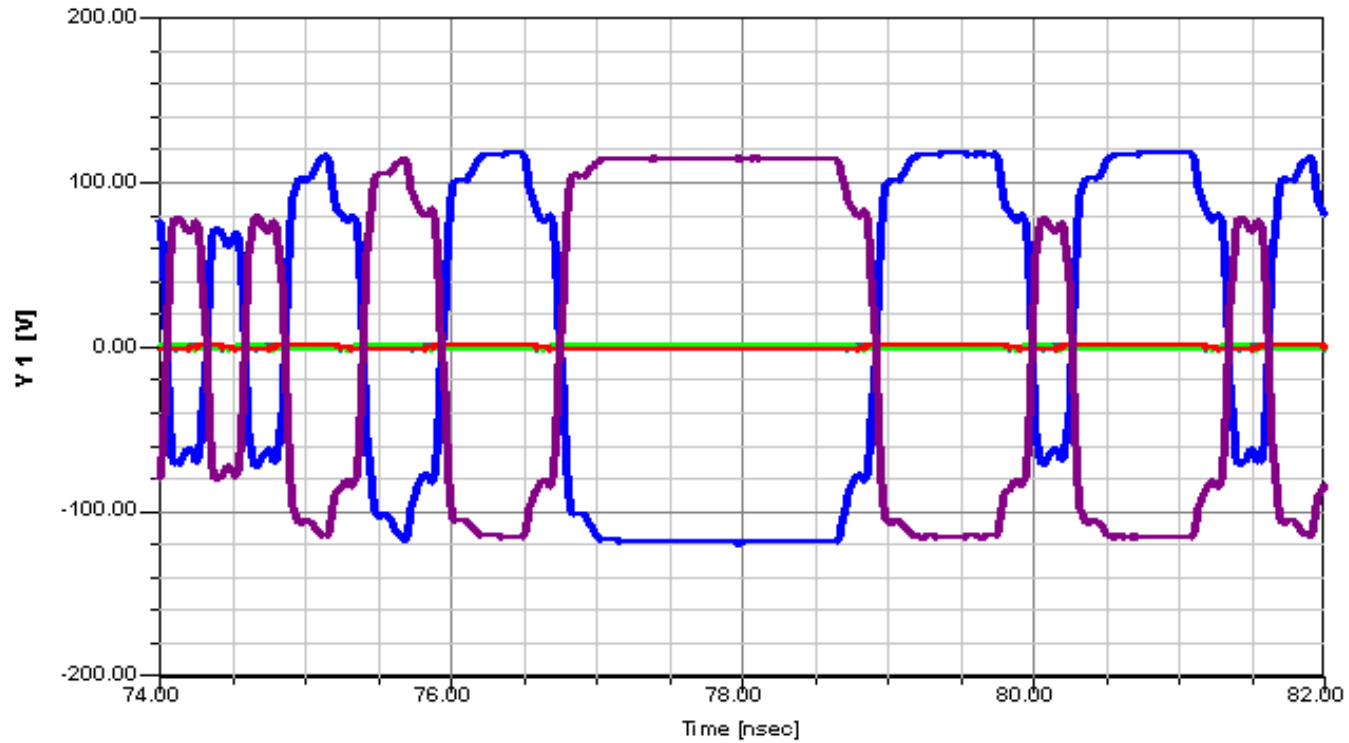
5.26GHz – same as first peak in S parameter plot

System-Level Model of Amplifier, PCB and Test Equipment

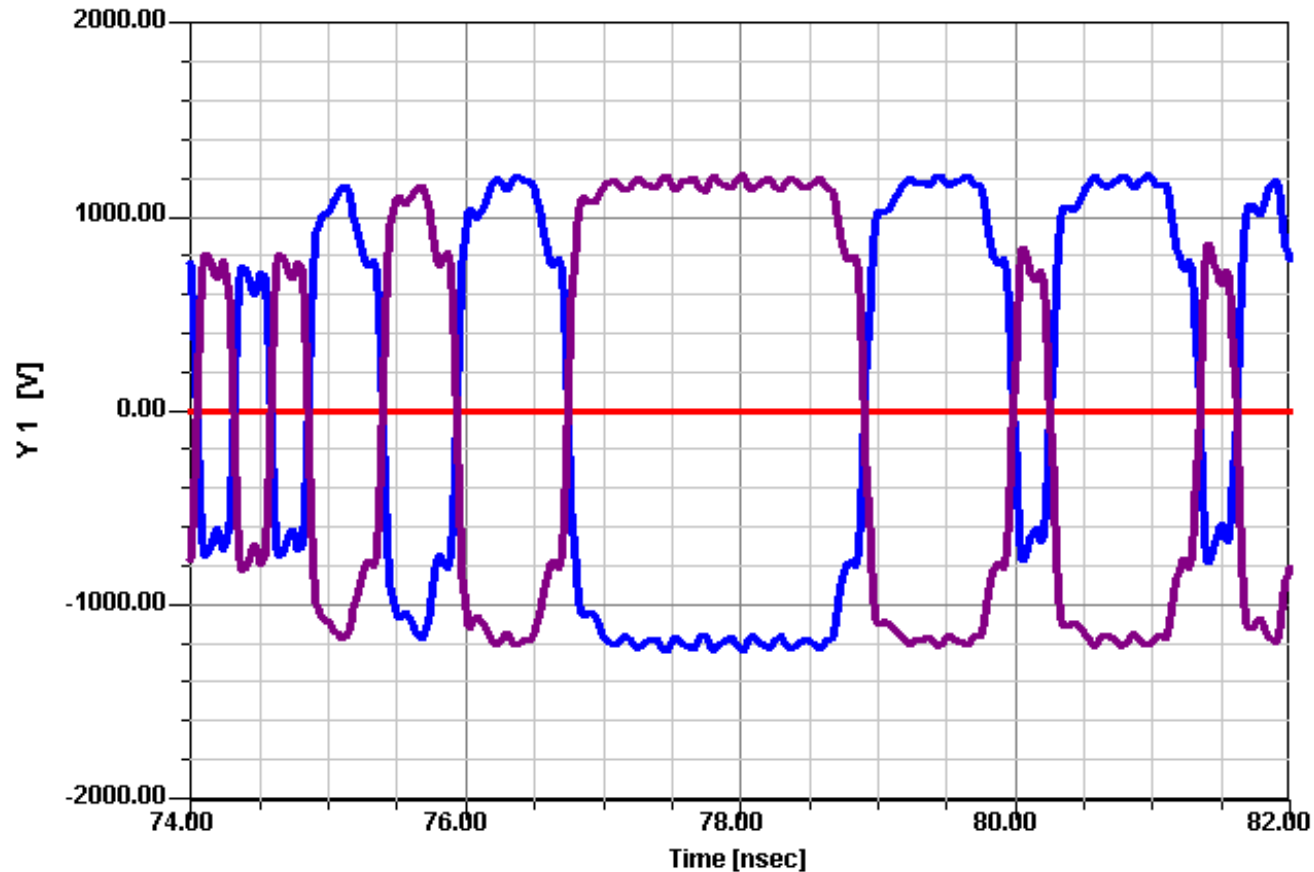


Output from Board

Low Gain, 3.7Gb/s Data Rate

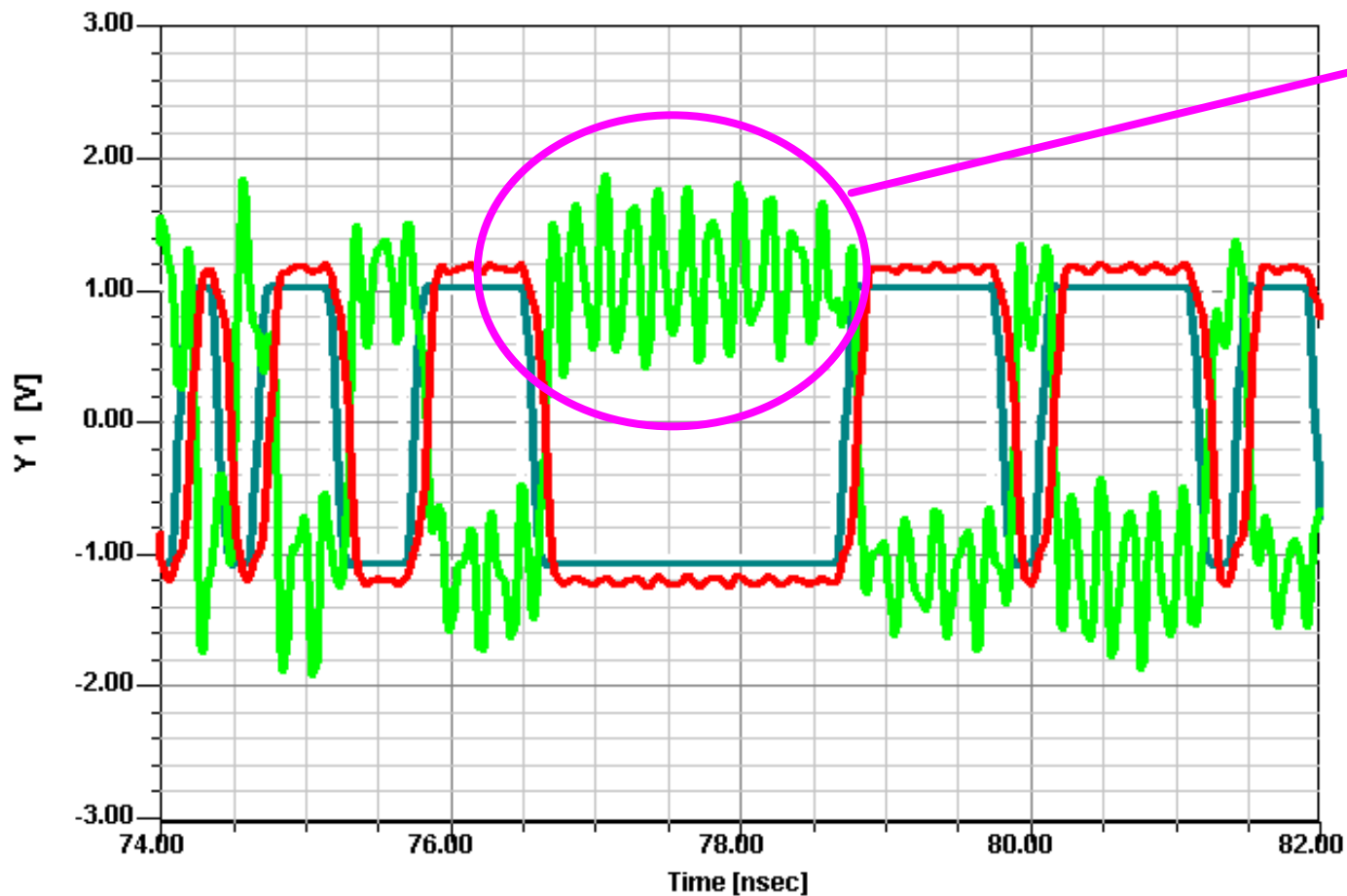


Output from Board High Gain, 3.7Gb/s Data Rate



Input to Amplifier

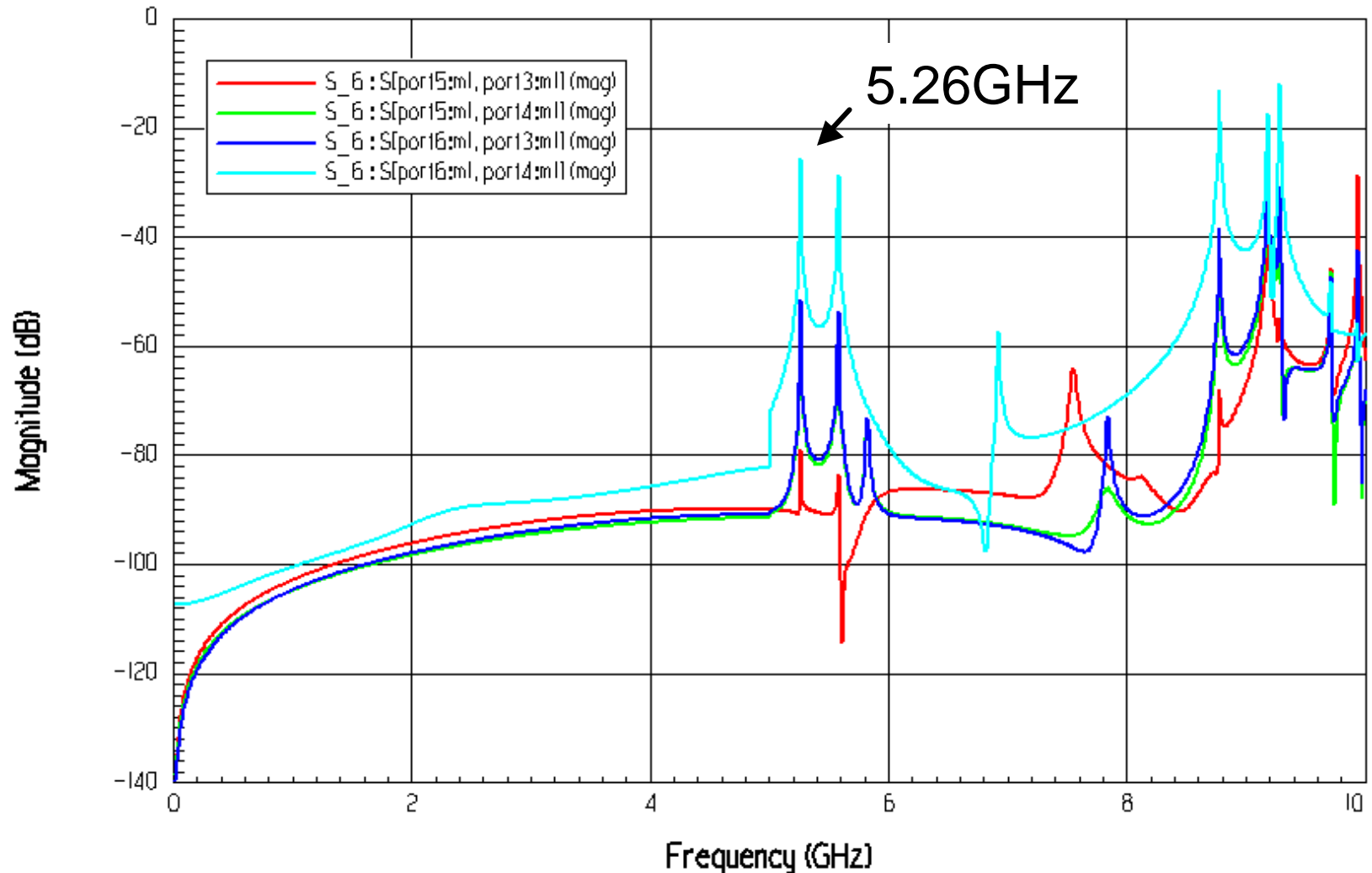
High Gain, 3.7Gb/s Data Rate



190ps
period

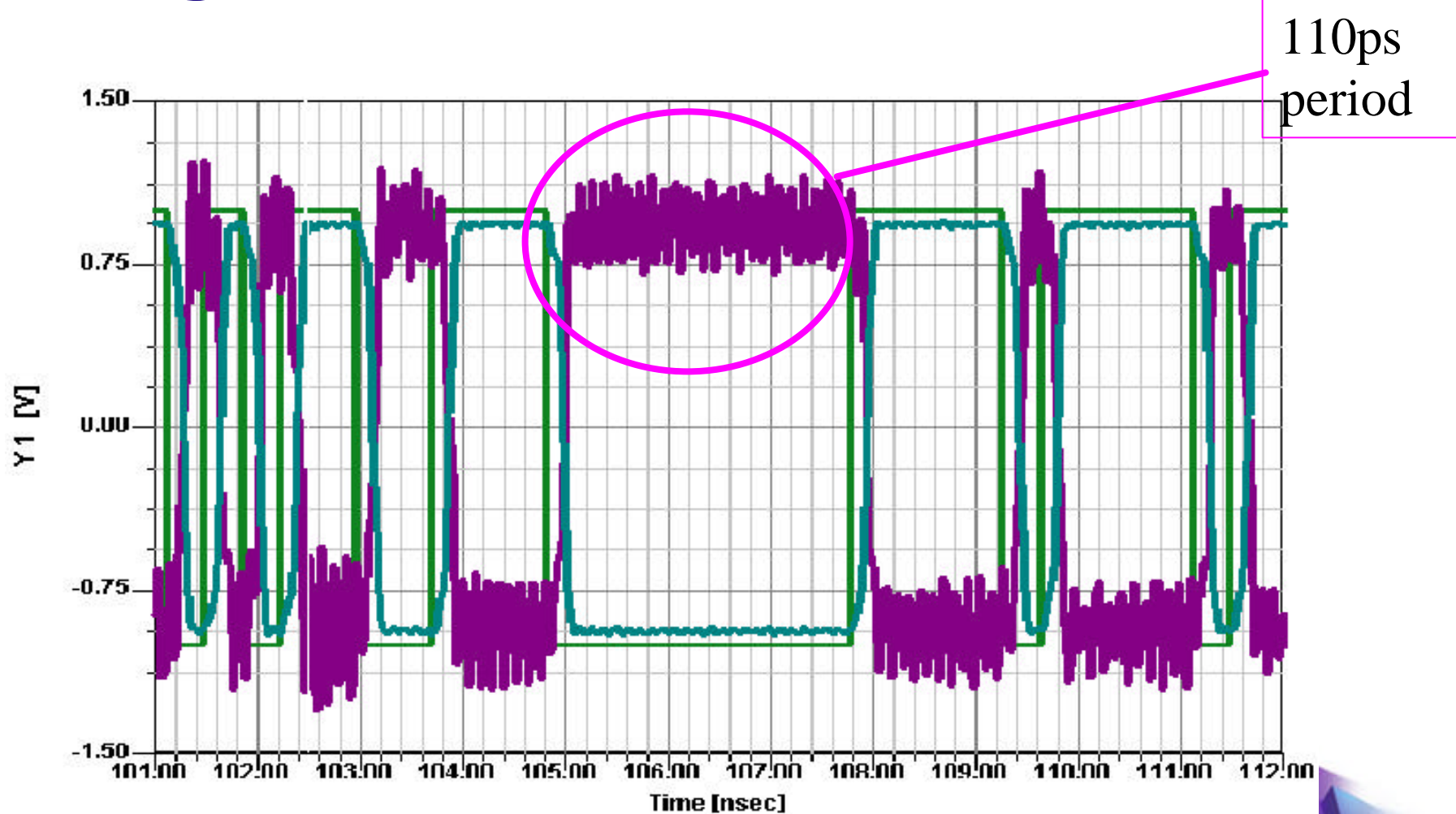
Coupling from Amplifier Output to Input

Amplifier Output to Input Feedback Coupling

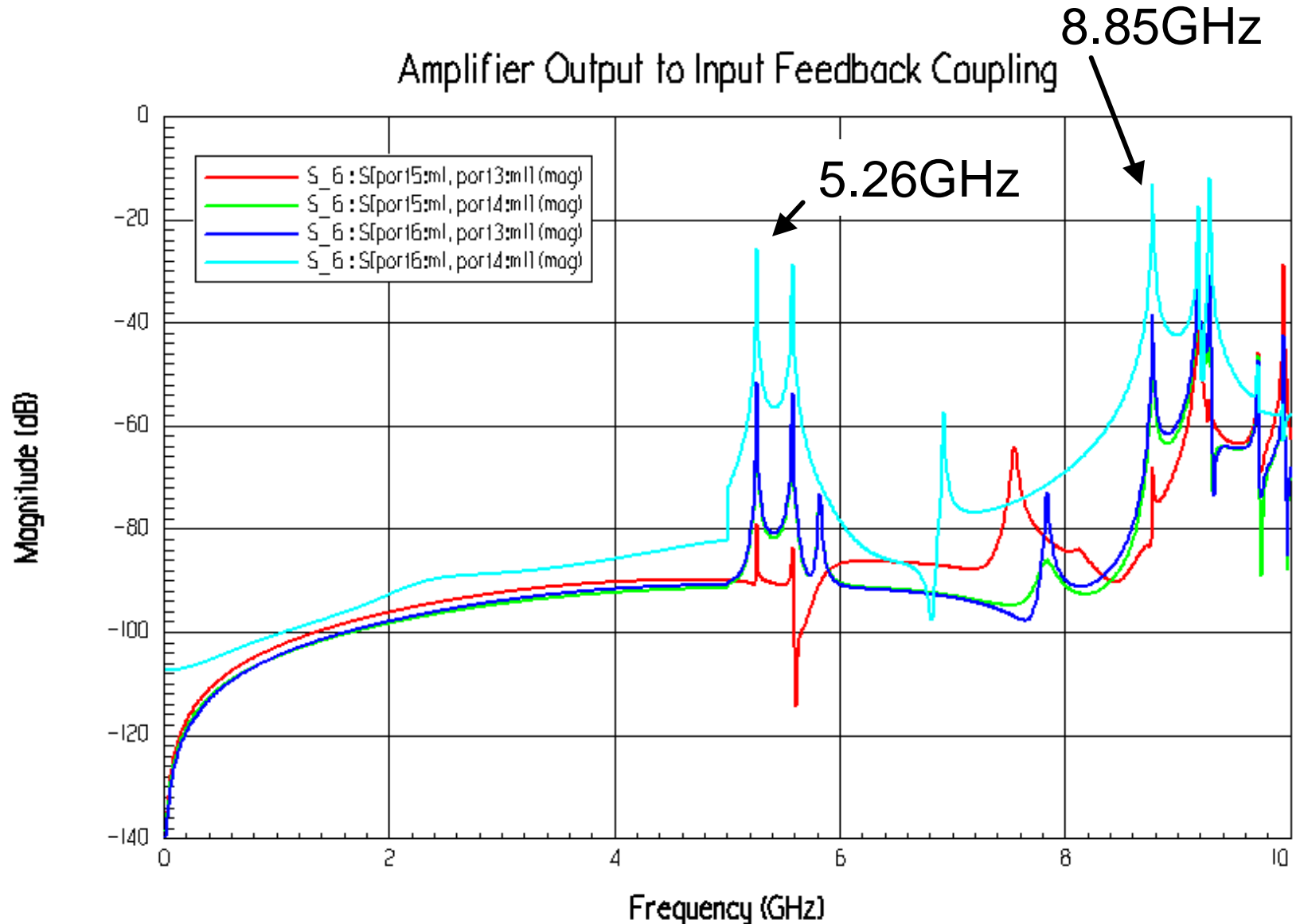


Input to Amplifier

High Gain, 2.7Gb/s Data Rate



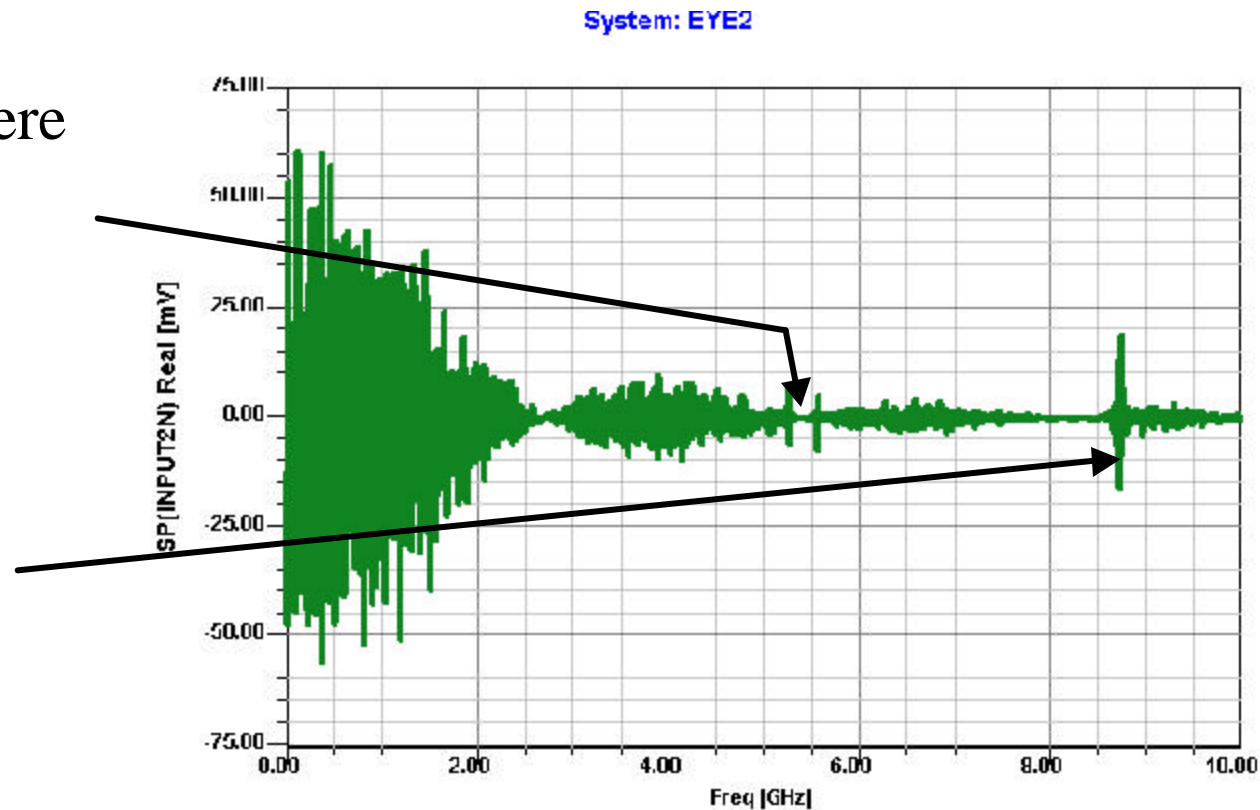
Coupling from Amplifier Output to Input



Input Spectrum at Amplifier High Gain, 2.7Gb/s Data Rate

Spectral null near
5.26GHz, so
resonances near here
are not strongly
excited

Significant
energy content at
8.85GHz, so
resonance is
excited



Summary

- ◆ High frequency applications (such as optical transceivers) are subject to a new class of “difficult” signal integrity problems not found at lower frequencies.
- ◆ Electromagnetic-based (EM) simulations predicts these effects, based upon a solution of Maxwell’s Equations, which describe the underlying physics.
- ◆ By incorporating models from the EM simulations into a system-level simulation, designers can predict the system performance across the domain of operation.
- ◆ Such virtual prototyping improves a designer’s insight into the high frequency signal integrity phenomena and leads to “right first time” designs.

